L Number	Hits	Search Text	DB	Time stamp
1	2	"20020050632"	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/03/29 11:53
2	252	$3Fe?sub.2O?sub.4	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/03/29 11:58
3	11514	((magnetic adj oxide) ferrite $3Fe?sub.2O?sub.4 manganite chromite cobaltite ($3Fe?sub.2 adj "O.sub.4")) near12 (shield$3 PWB PCB carrier substrate (lead adj frame) interposer (printed adj2 (circuit wiring)))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/03/29 12:21
4	2046	(((magnetic adj oxide) ferrite $3Fe?sub.2O?sub.4 manganite chromite cobaltite ($3Fe?sub.2 adj "O.sub.4")) near12 (shield$3 PWB PCB carrier substrate (lead adj frame) interposer (printed adj2 (circuit wiring)))) same (insulat$3 dielectric SiO2 SiN Si3N4 "SiO.sub.2" "Si.sub.3N.sub.4" ("Si.sub.3" adj "N.sub.4") polyimide)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/03/29 12:16
5	1675	((((magnetic adj oxide) ferrite $3Fe?sub.2O?sub.4 manganite chromite cobaltite ($3Fe?sub.2 adj "O.sub.4")) near12 (shield$3 PWB PCB carrier substrate (lead adj frame) interposer (printed adj2 (circuit wiring)))) same (insulat$3 dielectric SiO2 SiN Si3N4 "SiO.sub.2" "Si.sub.3N.sub.4" ("Si.sub.3" adj "N.sub.4") polyimide)) and @ad<20000831	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/03/29 12:16
6	9957	((magnetic adj oxide) ferrite $3Fe?sub.2O?sub.4 manganite chromite cobaltite ($3Fe?sub.2 adj "O.sub.4")) near12 (PWB PCB carrier substrate (lead adj frame) interposer (printed adj2 (circuit wiring)))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/03/29 12:22
7	1736	(((magnetic adj oxide) ferrite $3Fe?sub.2O?sub.4 manganite chromite cobaltite ($3Fe?sub.2 adj "O.sub.4")) near12 (PWB PCB carrier substrate (lead adj frame) interposer (printed adj2 (circuit wiring)))) same (insulat$3 dielectric SiO2 SiN Si3N4 "SiO.sub.2" "Si.sub.3N.sub.4" ("Si.sub.3" adj "N.sub.4") polyimide)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/03/29 12:16
8	1441	((((magnetic adj oxide) ferrite $3Fe?sub.2O?sub.4 manganite chromite cobaltite ($3Fe?sub.2 adj "O.sub.4")) near12 (PWB PCB carrier substrate (lead adj frame) interposer (printed adj2 (circuit wiring)))) same (insulat$3 dielectric SiO2 SiN Si3N4 "SiO.sub.2" "Si.sub.3N.sub.4" ("Si.sub.3" adj "N.sub.4") polyimide)) and @ad<20000831	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/03/29 12:17
9	237	((((magnetic adj oxide) ferrite $3Fe?sub.2O?sub.4 manganite chromite cobaltite ($3Fe?sub.2 adj "O.sub.4")) near12 (PWB PCB carrier substrate (lead adj frame) interposer (printed adj2 (circuit wiring)))) same (insulat$3 dielectric SiO2 SiN Si3N4 "SiO.sub.2" "Si.sub.3N.sub.4" ("Si.sub.3" adj "N.sub.4") polyimide)) and @rlad<20000831	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/03/29 12:17
10	1474	(((((magnetic adj oxide) ferrite $3Fe?sub.2O?sub.4 manganite chromite cobaltite ($3Fe?sub.2 adj "O.sub.4")) near12 (PWB PCB carrier substrate (lead adj frame) interposer (printed adj2 (circuit wiring)))) same (insulat$3 dielectric SiO2 SiN Si3N4 "SiO.sub.2" "Si.sub.3N.sub.4" ("Si.sub.3" adj "N.sub.4") polyimide)) and @ad<20000831) (((((magnetic adj oxide) ferrite $3Fe?sub.2O?sub.4 manganite chromite cobaltite ($3Fe?sub.2 adj "O.sub.4")) near12 (PWB PCB carrier substrate (lead adj frame) interposer (printed adj2 (circuit wiring)))) same (insulat$3 dielectric SiO2 SiN Si3N4 "SiO.sub.2" "Si.sub.3N.sub.4" ("Si.sub.3" adj "N.sub.4") polyimide)) and @rlad<20000831)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/03/29 12:17

11	1784	((magnetic adj oxide) ferrite $3Fe?sub.2O?sub.4 manganite chromite cobaltite ($3Fe?sub.2 adj "O.sub.4")) near12 shield$3	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/03/29 12:18
12	70	((((((magnetic adj oxide) ferrite $3Fe?sub.2O?sub.4 manganite chromite cobaltite ($3Fe?sub.2 adj "O.sub.4")) near12 (PWB PCB carrier substrate (lead adj frame) interposer (printed adj2 (circuit wiring)))) same (insulat$3 dielectric SiO2 SiN Si3N4 "SiO.sub.2" "Si.sub.3N.sub.4" ("Si.sub.3" adj "N.sub.4") polyimide)) and @ad<20000831) (((((magnetic adj oxide) ferrite $3Fe?sub.2O?sub.4 manganite chromite cobaltite ($3Fe?sub.2 adj "O.sub.4")) near12 (PWB PCB carrier substrate (lead adj frame) interposer (printed adj2 (circuit wiring)))) same (insulat$3 dielectric SiO2 SiN Si3N4 "SiO.sub.2" "Si.sub.3N.sub.4" ("Si.sub.3" adj "N.sub.4") polyimide)) and @rlad<20000831)) and (((magnetic adj oxide) ferrite $3Fe?sub.2O?sub.4 manganite chromite cobaltite ($3Fe?sub.2 adj "O.sub.4")) near12 shield$3)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/03/29 12:18
13	45	((((((magnetic adj oxide) ferrite $3Fe?sub.2O?sub.4 manganite chromite cobaltite ($3Fe?sub.2 adj "O.sub.4")) near12 (PWB PCB carrier substrate (lead adj frame) interposer (printed adj2 (circuit wiring)))) same (insulat$3 dielectric SiO2 SiN Si3N4 "SiO.sub.2" "Si.sub.3N.sub.4" ("Si.sub.3" adj "N.sub.4") polyimide)) and @ad<20000831) (((((magnetic adj oxide) ferrite $3Fe?sub.2O?sub.4 manganite chromite cobaltite ($3Fe?sub.2 adj "O.sub.4")) near12 (PWB PCB carrier substrate (lead adj frame) interposer (printed adj2 (circuit wiring)))) same (insulat$3 dielectric SiO2 SiN Si3N4 "SiO.sub.2" "Si.sub.3N.sub.4" ("Si.sub.3" adj "N.sub.4") polyimide)) and @rlad<20000831)) and (((magnetic adj oxide) ferrite $3Fe?sub.2O?sub.4 manganite chromite cobaltite ($3Fe?sub.2 adj "O.sub.4")) near12 shield$3)) and (circuit chip die semiconductor)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/03/29 12:22